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<th>Title</th>
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1 Revision History

The revision history describes the changes that were implemented in the document. The changes are listed by revision, starting with the most current publication.

1.1 Revision 5.0

Revision 5.0 was published in November 2018. The following is a summary of changes made in revision 5.0 of this document.

- Provided workaround for Libero programming on MPF300T Revision 4 devices. For more information, see Libero Programming on MPF300T Revision 4 Devices (see page 12).

1.2 Revision 4.0

Revision 4.0 was published in June 2018. The following is a summary of changes made in revision 4.0 of this document.

- Support for low common mode differential swing (LCMDS) I/O is removed in –ES/XT devices.
- VDD limit is added for programming to this errata.
- PCIe fails to re-transmit completion after link retrain. For more information, see PCIe Protocol Compliance Test with LeCroy Exerciser (see page 11).
- XCVR RXPLL may not recover when datastream is interrupted. For more information, see Incorrect Transceiver RXPLL Behavior/LANEx_RX READY Pin Behavior (see page 11).
- The ODT actually measured does not match with the ODT setting configured in the Libero. For more information, see SSTL15 Termination for GPIO (see page 12).
- LPDDR3 electrical compliance is not optimized as per the JEDEC specification. For more information, see LPDDR3 Electrical Compliance (see page 12).

1.3 Revision 3.0

Revision 3.0 was published in January 2018. The following is a summary of changes made in revision 3.0 of this document.

- Re-applied errata item for VDDI3 and VDD_XCVR_CLK power supply limits as included in revision 1.0.
- Edited title of errata item for hot-swapping/cold sparing on erased devices to include unexpected driven pins. For more information, see ER0207 Errata Descriptions and Workarounds (see page 5).
- The errata is edited to remove DDR3 GPIO support for ES/XT devices. For more information, see Supported Memory Interfaces (see page 12).

1.4 Revision 2.1

Revision 2.1 of this document was published in January 2018. There were no changes to the technical content.

1.5 Revision 2.0

Revision 2.0 was published in November 2017. New errata items were added in this revision. The following is a summary of changes made in revision 2.0 of this document.

- Updated table to provide the availability of the errata item. For more information, see Summary of PolarFire FPGA Errata (see page 5).
- Added a note with a reference to the package pin assignment tables. For more information, see Impacted Pins on Erased Devices (see page 7).
- Updated re-programming failure using FlashPro errata item. For more information, see Re-programming Failure using FlashPro (JTAG Programming) (see page 9).
- The Transceiver Protocol and Memory Interface tables were added. For more information, see Supported Transceiver Protocols (see page 14) and Supported Memory Interfaces (see page 12).
The following items from the Revision 1.0 errata were removed, as they were found to no longer be an issue in -ES devices or with PolarFire v2.0 software improvements.

- PCIe AXI slave interface has lower than expected throughput
- Transaction layer clock behavior of PCIe clock
- CCC-PLL lock output can glitch after reset has occurred using DEVRSTN pin
- LSRAM read before write (RBW) mode

1.6 Revision 1.0

Revision 1.0 was published in June 2017. It was the first publication of this document.
2 Errata for PolarFire Engineering Samples

The PolarFire® FPGA family engineering samples (ES) are subject to the limitations described in this errata. This document contains updated information about any known engineering sample-specific issues and provides the available limitations and workarounds. Engineering sample issues identified in this errata will be corrected in subsequent revisions of the devices listed in the following table. This errata highlights dependencies between silicon device revisions and specific support by Libero® PolarFire SoC software versions. Contact Microsemi Technical Support for more information.

2.1 Sample Revisions

The following table lists the sample revisions released. If not specified, the errata items impact all ES revisions listed in the table.

Table 1 • Sample Revisions Released per Device

<table>
<thead>
<tr>
<th>Devices</th>
<th>Packages</th>
<th>Revisions</th>
</tr>
</thead>
<tbody>
<tr>
<td>MPF300T</td>
<td>FCG1152, FCG784, FCG484, FCG484, and FCG536</td>
<td>0, 1, 2, 3, 4</td>
</tr>
</tbody>
</table>

The following table lists the operating conditions for the PolarFire engineering samples. The operating conditions for production devices follow datasheet specifications. These operating conditions are for engineering samples only. See DS0141: PolarFire FPGA Datasheet for production specifications.

Table 2 • PolarFire Engineering Sample Operating Conditions

<table>
<thead>
<tr>
<th>Operation Temperature Range</th>
<th>VDD Core Voltage Programming Only</th>
<th>Program/Erase</th>
<th>Retention Lifetime</th>
<th>sNVM Endurance</th>
<th>FPGA Endurance</th>
</tr>
</thead>
<tbody>
<tr>
<td>0 °C to 50 °C</td>
<td>0.97 V to 1.03 V</td>
<td>20 °C to 50 °C</td>
<td>1 year</td>
<td>1000 cycles</td>
<td>200 cycles</td>
</tr>
</tbody>
</table>

1. \( T_j \) = Junction temperature.
2. This only impacts programming voltages of revisions 0, 1, 2, and 3. Revision 4 and later supports \( V_{DD} \) of a range of 1.02 V to 1.08 V (1.05 V is the typical value).

2.2 PCB Designs

For information about how to determine proper signal pinout, see UG0726: PolarFire FPGA Board Design User Guide. The proper signal pinout is required for all clocking, transceiver, and FPGA pin recommendations.
2.3 Engineering Sample Device Identification

PolarFire FPGA engineering samples can be identified by the temperature grade field in the lower left-hand corner. As the following illustration shows, an ES annotation will appear in the temperature grade field indicating device is engineering sample and revision marking is shown along right side of code mark.

Figure 1 • ES Identification Markings
3  Errata Descriptions and Workarounds

The following sections describe device errata and the workarounds wherever applicable.

The following table lists the specific device erratas and the affected PolarFire ES devices. For die revision part marking specification, see ES Identification Markings (see page 4).

Table 3 • Summary of PolarFire FPGA Errata

<table>
<thead>
<tr>
<th>Description</th>
<th>Silicon Revisions</th>
<th>Errata Removal Details</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>MPF300T</strong></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Power supply sequencing</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>Bank3 VDDI, VDD_XCVR_CLK and XCVR_VREF[1:2] reduced from specification</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>Hot-swapping/cold sparing support on any I/Os powered by VDDI3 or XCVR_CLK_VDD banks</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>Hot-swapping/cold sparing on erased devices/unexpected driven pins</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>Calibration of FPGA I/O buffers</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>SmartDebug active probe speed</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>Missing global clock connection in XCVR Quad1</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>Inefficient usage of asynchronous dual-port LSRAM blocks</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>GPIO IOCDR SGMII</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>SmartDebug active probe write</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>PCIe core initialization</td>
<td>* X X X X</td>
<td>Libero SoC PolarFire v1.1 SP1 is required</td>
</tr>
<tr>
<td>HSIO and GPIO drive strength</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>PCIe transmit compliance with a 50 Ω load</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>Voltage reference sensitivity issue</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>LVDS VOS output common mode specification</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>Vref power estimation</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>Re-programming failure using FlashPro (JTAG programming)</td>
<td>* X X X *</td>
<td>Libero SoC PolarFire v1.1 SP1 is required</td>
</tr>
<tr>
<td>GPIO on-die termination</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>Transceiver polarity inversion</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>Lanes 2 and 3 are swapped between PCS to FPGA fabric</td>
<td>* X X *</td>
<td>Libero SoC PolarFire v2.0 required to correct issue</td>
</tr>
<tr>
<td>JTAG programming times</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>PCIe after asserting the PCIe_PERST_N port</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>SSTL18I I/O standard is not supported for PF_XCVR_REF_CLK</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>PCIe ECC detection</td>
<td>*</td>
<td></td>
</tr>
<tr>
<td>JTAG TCK duty cycle</td>
<td>*</td>
<td></td>
</tr>
</tbody>
</table>


### Description

<table>
<thead>
<tr>
<th>Silicon Revisions</th>
<th>Errata Removal Details</th>
</tr>
</thead>
<tbody>
<tr>
<td>MPF300T</td>
<td>0</td>
</tr>
</tbody>
</table>

#### Transceiver PCS mode 64b/6xb limitations
- * * * * *

#### Transceiver lock to reference clock limitation
- * * * * *

#### Limitations for ACJTAG IEEE 1149.6 for transceiver transmit pins
- * * * * *

#### Incorrect transceiver RXPLL behavior /LANEx_RX READY pin behavior
- * * * * *

#### Low common mode I/O types not supported
- * * * * *

#### Auto-update trigger
- * * * * *

#### PCIe protocol compliance test with LeCroy exerciser
- * * * * *

#### SSTL15 Termination for GPIO
- * * * * *

#### LPDDR3 electrical compliance
- * * * * *

#### MPF300T-ES Device with Revision 4 will not program within Libero project flow.
- NA | NA | NA | NA | *

### Unsupported Features

#### System controller suspend mode
- * * * * *

#### Flash*Freeze mode
- * * * * *

#### Temperature voltage sensor (TVS)
- * * * * *

#### Device zeroization
- * * * * *

#### Digest check
- * * * * *

#### Generic I/O gearing modes
- * * * * *

#### PCIe Gen2 electrical compliance for x2 and x4 links
- * * * * *

#### Automated DFE support (contact Microsemi)
- * * * * *

#### XCVR limitations for entire data rate range (contact Microsemi)
- * * * * *

### Feature Clarifications

#### Memory interfaces
List of currently supported memory interfaces with ES devices and Libero SoC PolarFire v2.0 software

#### Supported transceiver protocols
List of currently supported transceiver protocols with ES devices and Libero SoC PolarFire v2.0 software

**Note:** * indicates that the errata exists for that particular device and revision number. **Note:** X indicates that the errata is removed and no longer exists for that particular device and revision number (based on additional details).

### 3.1 Power Supply Sequencing

The engineering sample must follow this power-on sequence:

1. VDD to VDD operational minimum.
2. VDD2S to VDD2S operational minimum.
3. VDDI and VDDAUX must be powered up any time before VDD18 or simultaneously with VDD18, if supplied from same power source. If VDDI and VDDAUX are not tied to same voltage rail, then VDDI should be powered up before VDDAUX.

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4. \( V_{DD} \) (VPP) must be the last major supply in the power-up sequence. Other supplies that are not mentioned, such as power supplies related to transceivers, do not have mandatory sequence requirements. The \( V_{DD} \) power-supply can draw large currents at power-up or power cycling if the correct sequence is not followed.

For more information about the operational minimum voltages, see the DS0141: PolarFire FPGA Datasheet. Observe the power supply ramp rates specified in the datasheet.

Sequencing will not be required for production of MPF300T devices.

### 3.2 Bank3 VDDI, VDD_XCVR_CLK and XCVR_VREF[1:2] Reduced from Specification

Bank 3 VDDI, VDD_XCVR_CLK and XCVR_VREF[1:2] cannot exceed 2.5 V nominal.

### 3.3 Hot-Swapping/Cold Sparing Support on Any I/Os Powered by VDDI3 or XCVR_CLK_VDD Banks

This feature is not supported on any I/Os powered by \( V_{DD} \) or the transceiver reference clock input pins, including:

- SDO
- SDI
- FF_EXIT_N
- IO_CFG_INTF
- SPI_EN
- SCK
- DEVRST_N
- SS
- TCK
- TMS
- TDI
- TDO
- TRSTB
- XCVR_#A_REFCLK_P/N
- XCVR_#B_REFCLK_P/N
- XCVR_#C_REFCLK_P/N

There is no workaround for this issue.

### 3.4 Hot-Swapping/Cold Sparing on Erased Devices/Unexpected Driven Pins

The following table lists the 35 FPGA IO pins that do not support hot-swapping/cold sparing on erased devices.

<table>
<thead>
<tr>
<th>Bank</th>
<th>GPIO Pins</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>HSI0169PB0, HSI0170PB0, HSI0171PB0, HSI0173NB0</td>
</tr>
<tr>
<td>1</td>
<td>HSI072NB1, HSI073PB1, HSI074PB1, HSI075PB1, HSI079PB1, HSI080PB1, HSI081PB1</td>
</tr>
<tr>
<td>2</td>
<td>GPIO244NB2, GPIO246PB2, GPIO247PB2, GPIO248PB2, GPIO26PB2, GPIO27PB2, GPIO28PB2, GPIO29PB2, GPIO32PB2, GPIO33PB2, GPIO34PB2, GPIO35NB2</td>
</tr>
<tr>
<td>4</td>
<td>GPIO174PB4, GPIO180PB4, GPIO181PB4</td>
</tr>
<tr>
<td>5</td>
<td>GPIO238PB5, GPIO239PB5, GPIO241PB5</td>
</tr>
<tr>
<td>6</td>
<td>HSI062PB6, HSI063PB6, HSI064PB6, HSI065PB6, HSI068PB6, HSI069PB6, HSI070PB6, HSI071NB</td>
</tr>
</tbody>
</table>
Note: This errata is only applicable to erased parts. Programmed parts do not have the errata. If these pins are used as input or bi-directional buffers, an erased device will actively drive these outputs rather than being properly disabled. For more information about the pin numbers, see the MPF300T/MPF300TS package pin assignment tables at https://www.microsemi.com/products/fpga-soc/fpga/polarfire-fpga.

If the part is not programmed, do not use these pins even if required for hot-swapping/cold sparing applications.

3.5 Calibration of FPGA I/O Buffers
The FPGA I/O buffers have calibration circuitry to optimize and match the I/O impedance and termination within a system. The calibration occurs, every time the device is powered up. After the device power-up, re-calibration is not available on command.

The device requires a power-cycle to correctly re-calibrate.

3.6 SmartDebug Active Probe Speed
The live probe output cannot toggle faster than 100 MHz.

There is no workaround for this issue.

3.7 Missing Global Clock Connection in XCVR Quad1
Designs cannot utilize two global clocks for XCVR Quad1. Designs have access to only one global clock on Quad1.

In the Libero SoC PolarFire transceiver lane configurator, the user can select the clock resources used for transmit, receive, and global or regional clocks. For lanes assigned to Quad1, only a single global connection is available. This implies that only one lane in that quad and one direction of that lane can select global in this interface. Therefore, the clocks assigned to LANE#_RX_CLK_[G] and LANE#_TX_CLK_[G] are limited to one across all lanes in a quad.

3.8 Inefficient Usage of Asynchronous Dual-Port LSRAM Blocks
For LSRAM blocks configured as asynchronous dual-ports, when port A is greater than x20, twice the number of required LSRAM blocks are used.

Two 1K × 20 LSRAM blocks are automatically instantiated by Libero SoC PolarFire to implement the single 512 × 40 LSRAM.

3.9 GPIO IODCDR SGMII
IOD CDR interfaces cannot be used with a >0 ppm offset. For SGMII, the PHY device and PolarFire IOD CDR must use the same reference clock. SGMII interfaces using transceivers are not affected by this limitation.

SGMII can be implemented with IODCDR using 0 ppm or a common clock using the same clock configuration for both Tx and Rx clocks.

3.10 SmartDebug Active Probe Write
SmartDebug active probe write operation is not available. Active probe read operation functions as documented.

There is no workaround for this issue.

3.11 PCIe Core Initialization
PCIe is not correctly initialized after programming the device.

This impacts only the silicon revision 0 and software prior to Libero SoC PolarFire v1.1 SP1.
3.12 **HSIO and GPIO Drive Strength**

HSIO and GPIO drive strength deviates by up to ±20% from the datasheet specifications.

There is no workaround for this issue.

3.13 **PCIe Transmit Compliance with a 50 Ω Load**

PCIe fails to automatically enter into transmit compliance when used with a 50 Ω load.

There is no workaround for this issue.

3.14 **Voltage Reference Sensitivity Issue**

There is a voltage reference sensitivity issue with HSIOs when V\textsubscript{DD18} and V\textsubscript{DD25} supply voltage rail separation is too large. This effects the HSIO buffer banks only.

This issue is managed by reducing the separation between V\textsubscript{DD25} and V\textsubscript{DD18}. For example, when V\textsubscript{DD25} is maximum, then V\textsubscript{DD18} needs to be maximum or when V\textsubscript{DD25} is typical, then V\textsubscript{DD18} needs to be typical. If V\textsubscript{DD18} and V\textsubscript{DD25} are minimum and the other maximum (respectively), it will influence the effectiveness of the voltage references of HSIO banks, preventing I/O buffers from correctly functioning.

3.15 **LVDS VOS Output Common Mode Specification**

The LVDS VOS output common mode specification can vary as much as 175 mV below the datasheet specification.

3.16 **VDD Power Estimation**

The PolarFire power estimator (v3e) is currently optimistic with regard to the estimated V\textsubscript{DD} static power. It is expected that the designs utilizing ES silicon can have a 40% higher current on the V\textsubscript{DD} power supply compared to the provided estimation.

3.17 **Re-programming Failure using FlashPro (JTAG Programming)**

Designs that have stored device initialization in µPROM or external SPI will fail reprogramming with FlashPro and receive the following error message.

"Error: programmer 'S201Z7FK2R': Executing action PROGRAM FAILED, EXIT -38."

The error condition can be cleared by re-attempting programming. This issue is only identified in MPF300-ES Rev0 devices.

3.18 **GPIO On-Die Termination**

The on-die pull-up of the Thévenin's termination can be as high as 2x. This causes a weak on-die termination (ODT).

The user can select a stronger termination value for the design. This issue is automatically adjusted in the Libero SoC PolarFire v2.0 software.

3.19 **Transceiver Polarity Inversion**

There is no programmable receiver polarity inversion possible on the transceivers for 8b10b, 64b6xb, and PMA modes.

There is no workaround for this issue.

3.20 **Lanes 2 and 3 are Swapped Between PCS to FPGA Fabric**

This effects 8b10b, 64b6xb, PIPE, and PMA PCS modes and is identified with Libero SoC PolarFire v1.1 SP1 software or earlier.
For example, lanes 2 and 3 are swapped while using PIPE mode, and a TS1 packet is "00 01 03 02" instead of "00 01 02 03" for a x4 link.

This issue is resolved in Libero SoC PolarFire v2.0 software.

### 3.21 JTAG Programming Times

FPGA programming using the FlashPro4 or 5 programming cable exceeds the current datasheet programming specifications. This also impacts programming times of external SPI flash devices with PolarFire using the FlashPro cable.

See the Libero SoC PolarFire v2.1 Release Notes for specific details.

For more information regarding actual programming specifications, see DS0141: PolarFire FPGA Datasheet.

This is not a device limitation, but occurs due to inherent speed of the cable, and will be addressed in a subsequent release of new FlashPro hardware.

### 3.22 PCIe After Asserting the PCIE_PERST_N Port

After a PCIe link is established at Gen2 speed, toggling the PCIE_PERST_N port of the PCIe block can cause the PCIe to fail to re-enumerate or re-establish link. For example, a Gen2 (5 Gbps) link will not re-establish link if the PCIE_PERST_N port is toggled.

When PERST# is asserted in L2/P2 state, the device fails to exit L2 as expected.

An FPGA fabric workaround is available to mitigate this issue. Contact Microsemi for more information.

### 3.23 SSTL18I I/O Standard Not Supported for PF_XCVR_CLK

The SSTL18 I/O type is not supported in the PF_XCVR_REF_CLK input pins, as shown in the UG0677: PolarFire FPGA Transceiver User Guide.

LVDS25, HCSL25, and LVCMOS25 I/O types can be used as alternative inputs.

### 3.24 PCIe ECC Detection

The embedded ECC functions of the PCIe core that provide indicators for single-error correction (SEC) and double-error detection (DED) data detection is improperly functioning. These flags are tied to the incorrect operation of PCIE_#_M_RDERR/WRERR and PCIE_#_S_RDERR/WRERR pins of the PCIe embedded core.

The error-correcting logic is functional. The SECDED status indicators are incorrect.

For certain situations, an FPGA fabric workaround is available to mitigate this issue. Contact Microsemi for more information.

### 3.25 JTAG TCK Duty Cycle

The minimum and maximum specifications for JTAG TCK duty cycle deviate from the datasheet values, 25 MHz TCK with 45/55% duty cycle.

### 3.26 Transceiver PCS Mode 64b/6xb Limitations

The 64-bit data bus of the fabric interface for mode 64b6xb is permitted for the lanes, Q0 LANE{0, 1, 2, 3} and Q(1-S) LANE{0,2}. The 32-bit data bus of the fabric interface can be used on all lanes of all transceiver quads.
3.27 **Transceiver Lock to Reference Clock Limitation**
The RX_CLK stops for a specific period of time in burst mode receiver (BMS) mode when the user changes the mode to lock-to-reference-clock-mode using control pins from the FPGA fabric. The minimum period of time is 1,024 REFCLK cycles and the maximum is 10,240 REFCLK cycles over the REFCLK frequency range of 100 MHz–312 MHz.

3.28 **Limitations for ACJTAG IEEE 1149.6 for Transceiver Transmit Pins**
For transceiver transmit pins, the following ACJTAG IEEE 1149.6 limitations exist:

- The instruction EXTEST_PULSE actually implements EXTEST_TRAIN instruction.
- The transceiver transmitter transmits the signals at very low amplitude during any AC or DC JTAG instructions.

3.29 **Incorrect Transceiver RXPLL Behavior/LANEx_RX_READY Pin Behavior**
The transceiver LANEx_RX_RECEIVED pin toggles when the Rx signal is open or disconnected, or while an out-of-range condition occurs. For example, incorrect Rx serial data rates, with serial input data >1.17% away, is considered out of range. Initially, the Rx CDR lock may not lock with missing or bad data stream.

The following conditions prevent the incorrect behavior:

- The Rx data rate is <±300 ppm of the Libero configured rate.
- Rx data is present when PMA_ARST is de-asserted.
- Data stream must not stop once locked.
  - PMA_ARST can be used to restart.

Contact Microsemi Technical Support at soc_tech@microsemi.com for a workaround.

3.30 **Low Common Mode I/O Not Supported**
Low common mode I/O is not supported in PolarFire XT devices. Libero SoC PolarFire software allows for the selection, but the device does not support it.

3.31 **Auto-Update Trigger**
The system controller triggers auto-update when the design version is not equal to current design version.

MPF300-ES auto-update criterion is that the system controller starts auto-update if the design version in the bit stream is greater than the design version in the device.

3.32 **PCIe Protocol Compliance Test with LeCroy Exerciser**
PolarFire device testing for PCIe compliance with a LeCroy exerciser reports a failure for a PTC test related to REPLY_BUFFER.

However, PTC test conducted on the keysight exerciser passed successfully.

PolarFire met full compliance at the PCISIG Compliance Workshop #101 and entry into the integrators list.

PTC Test 52-20 (LinkRetrainOnRetryFail) fails in the LeCroy testing suite. Root-cause is that the PCIe controller executes some of the second-round replays prior to, rather than after, link re-training.

Functional impact to this issue is low because no transaction layer packet (TLP) is lost due to the built-in replay mechanism required by the PCIe base specification. Replays will occur both before and after link re-training as long as TLP is not acknowledged.
3.33 **SSTL15 Termination for GPIO**
The 20 Ω and 30 Ω ODT for GPIO SSTL15I and SSTL15II settings should not be used. Instead use a setting of 40 Ω or above.

3.34 **LPDDR3 Electrical Compliance**
LPDDR3 electrical compliance as per the JEDEC JESD79-3E and JESD79-3-1 DDR3 SDRAM specifications are not completely optimized with designs implemented in the Libero software.

3.35 **Libero Programming on MPF300T Revision 4 Devices**
MPF300T -ES devices with Revision 4 will not program within Libero project flow. Use the following steps for the Libero PolarFire 2.x workaround.

1. Export STAPL file in Libero for -ES device.
2. Load the STAPL file into standalone FlashPro in PFv2.X using single STAPL mode.

*Note:* More information can be found in knowledge base article [Libero PolarFire programming limitation of some variant of PolarFire devices](#).

3.36 **Unsupported Features**
The following is a list of unsupported features. The features listed are not supported by engineering samples, but production devices have been updated to support these features.

- System controller suspend mode
- Flash*Freeze mode
- Temperature voltage sensor (TVS)
- Device zeroization
- Digest check
- Generic I/O gearing modes
  - Simulation-only support available in the Libero SoC PolarFire v2.0
- PCIe Gen2 electrical compliance for x2 and x4 links
- Automated DFE support
  - Contact Microsemi for DFE support
- XCVR limitations for entire data rate range

Current support is limited to 10.3 Gbps and below. Contact Microsemi for solutions outside support listed in the [UG0677: PolarFire FPGA Transceiver User Guide](#).

3.37 **Supported Memory Interfaces**

The following table highlights the current DDR3 and DDR4 capabilities per device and package combinations with all MPF300-ES silicon revisions and Libero SoC PolarFire v2.x. Additional capabilities will be added upon completion of silicon validation and software inclusion.
### Table 5 • MPF300-ES Supported Memory Standards

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<th>IO Type</th>
<th>Edge._Anchor</th>
<th>Memory Type</th>
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<th>STD (Mbps)</th>
<th>–1 (Mbps)</th>
<th>Interface Width (Max)</th>
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</table>
## Supported Transceiver Protocols


The following table summarizes the transceiver protocols supported by all MPF300-ES silicon revisions with Libero SoC PolarFire v2.0. Additional capabilities will be added upon completion of silicon validation and software inclusion.

### Table 6 • Supported Transceiver Protocols

<table>
<thead>
<tr>
<th>Transceiver Protocol</th>
<th>Details</th>
</tr>
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<tbody>
<tr>
<td>SGMII/1000BaseX</td>
<td>Transceiver: 1.25 Gbps with CoreTSE IP Core TxPLL SyncE not supported</td>
</tr>
<tr>
<td>CPRI</td>
<td>Support for CPRI data rates 1–6</td>
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<tr>
<td>10GBASE-R</td>
<td>Transceiver: 10.3 Gbps with Core10GMAC IP Core TxPLL SyncE not supported IEEE 1588 time stamping not supported</td>
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<td>SATA 1-2-3</td>
<td>PHY layer supported. Contact Microsemi.</td>
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<td>Interlaken</td>
<td>Contact Microsemi for support</td>
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<td>JESD204B</td>
<td>Up to 10G with CoreJESD20BTX/RX IP Core</td>
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<tr>
<td>PCIE Endpoint Gen1/Gen2</td>
<td>See Summary of PolarFire FPGA Errata (see page 5)</td>
</tr>
<tr>
<td>PCIE Rootport Gen1/Gen2</td>
<td>See Summary of PolarFire FPGA Errata (see page 5)</td>
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<tr>
<td>LiteFast</td>
<td>Up to 5 Gbps</td>
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</table>

1. See the Package Pin Assignment Tables (PPAT) for information regarding anchor locations.
2. See LPDDR3 electrical compliance limit.